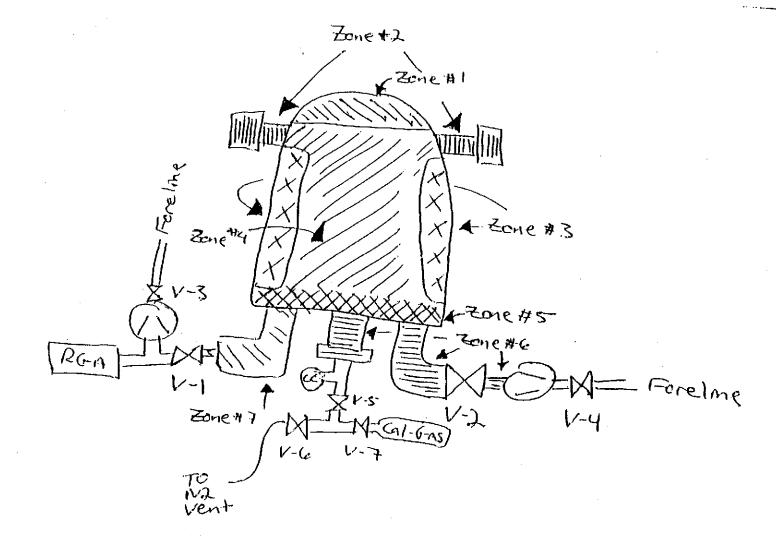
Summary of LHO Vacuum Bake Oven A RGA Data Generation

The individual parts which comprise a "load" are cleaned as per LIGO-E960022 or as allowed by waiver(s) and loaded into the bake oven. The oven is then pumped down through the main pump "arm" (through V-2, RGA arm is valved off at this point). A heating profile is programmed and baking of the system begins. A typical "heating profile" consists of ramping up to material type soak temperature, soaking for approximately 48 hours, ramping down to approximately 70C, soaking and then ramping down to near room temperature. While soaking at 70C, an RGA background scan is taken. V-1 is then opened and V-2 closed. Enough time is allowed for the system to come into pressure equilibrium and then an elevated load temperature RGA scan is taken. V-1 is then closed and V-2 opened. Following this elevated temperature scan, the load is ramped down to near room temperature and the baking portion of the process is complete. Throughout the baking, temperature data is taken to verify the actual temperatures in the various "heat zones" of the bake oven system.

Once at near room temperature, another RGA background (V-1 closed) scan is taken. Next, V-1 and the cal-gas are opened and V-2 closed. After a 30 minute pressure equilibration time, a "calibration" scan is taken. The calculated pressure of Argon (constituent of the "mixed" calibration gas) is determined using the leak rate of Argon and the pump speed of the RGA arm port as seen by the oven chamber and compared (ratio) to the maximum amp value measured for Argon in the calibration scan. This "torr/amp" ratio becomes the Calibration Factor for the given load, converting measured current to pressure.

Finally, the cal-gas is valved out and enough time is allotted to allow all traces of it to be pumped away. A "post-bake" scan is then taken. Approval of the post-bake scan is a collective "pass/fail" determination made by either Dennis Coyne (CalTech) or Stan Whitcomb (CalTech). The data collected during the "elevated temperature scan" is entered into a spreadsheet which then calculates what the outgassing rates of AMUs 41, 43, 53, 55 and 57 ought to be at room temperature. These calculations are used to determine the room temperature outgassing rates when the signals are below the RGA's sensitivity (noise floor).

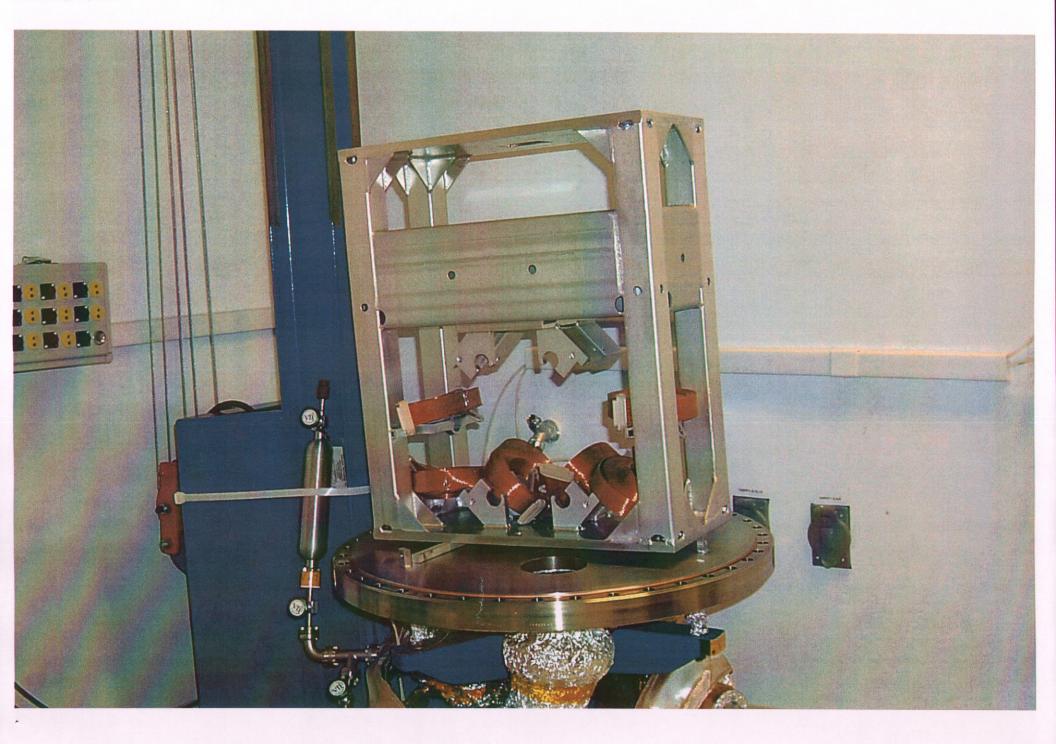
Refer to the LHO Vacuum Bake Oven A logbook for the actual ordered events of the load # of interest.

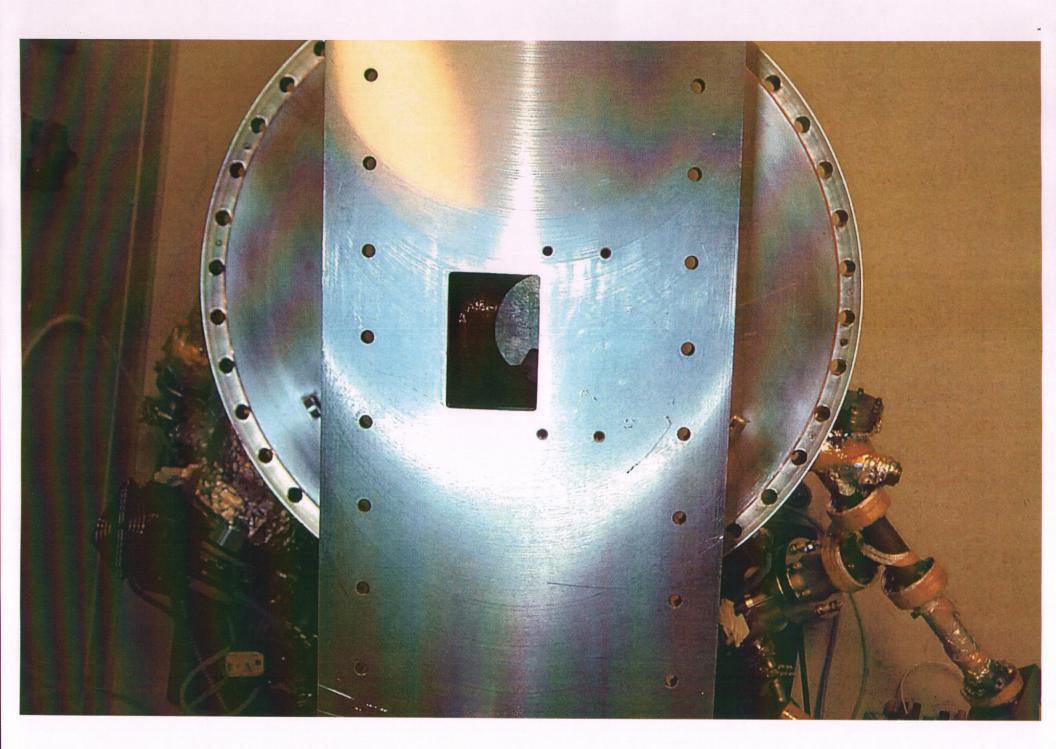


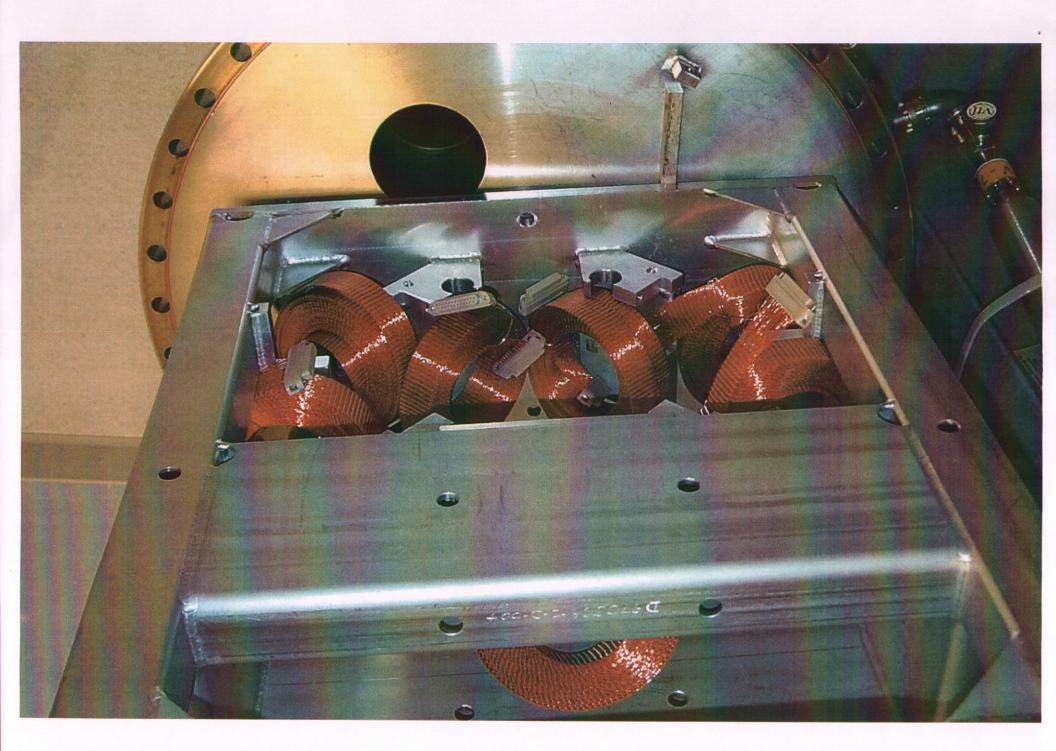
LHO VACUUM BAKE OVEN A: CONTENTS LOAD #58

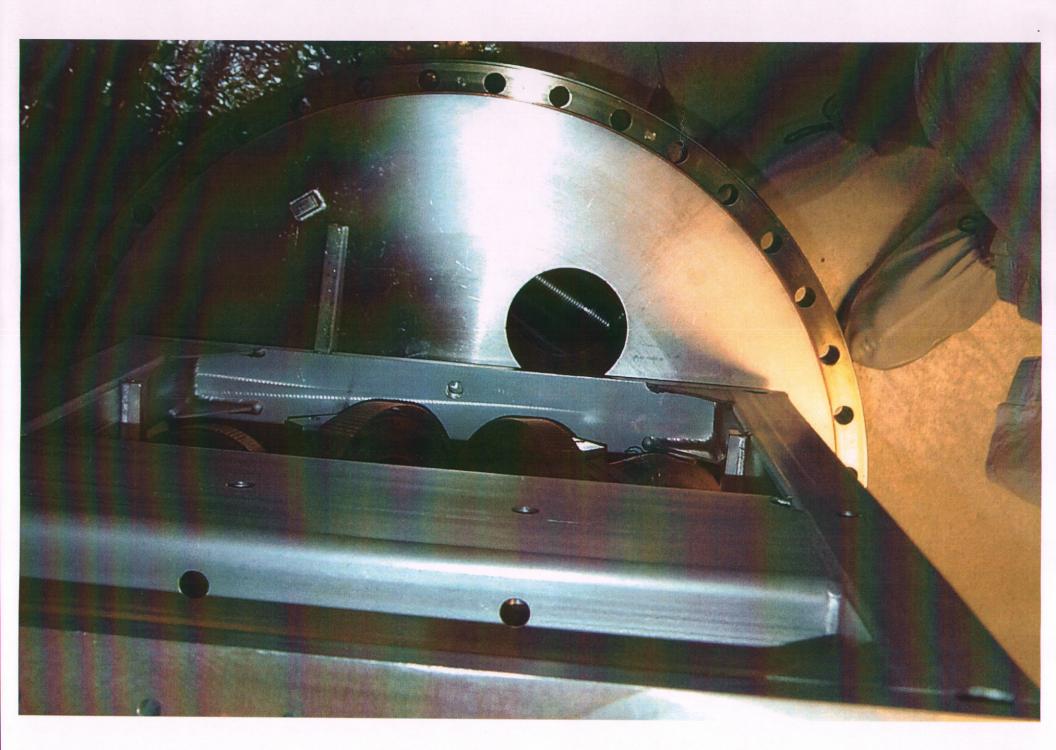
L.O.S. STRUCTURE SERIAL NUMBER D970506-004

KAPTON CABLES (7ea) SERIAL NUMBER N/A









LIGO PROCESS TRAVELER

DCC Number: E990357-00-X
Date Prepared: 9-28-99

Janeen Romie - for Betsy Weaver		Janeen Romie	#8445	<u>Parting and State of the Control of</u>	5F518=LIGO.5F500,2.8,	
Dwg/Pa	rt Number Re	Part Description		Seria	NSFLIGO.5F500	
D970506	С	LOS Structure 304 LOS2 Structure Assembly, Beamsplitte	LOS Structure 304 Stainless			
Jsed In (nex	t higher assembly):	Suspension Top Assemblies: D970506 for BS; D970505 and D970539				
超级风油。	医细胞层侧侧	endor Name		PO/Cor	ntract Number	
	lachine, West Brookfield	MA	PC25368	1 1 14 M 14 14 14 17 1 1 1 1 1 1 1 1 1 1 1 1 1 1	TO THE PARTY OF TH	
Inspection Required Y	, Receiving/Inspection Visual N Damage Y/N	Kemarks: Comments			Name/ Date Initials Le Comb	
Y	Di	ee Attached Procedure. ip a cotton swab in acetone and swab the inside the procedure of the inside	consult S. White	egs. If swab omb or D.		

#	Operation	Start Date	Work Area	Instructions	Name/s Initials	Date Comp
1	Clean		LLO	See Attached Procedure. The weldments have been pickled and wrapped, therefore, rinse thoroughly with DI water. Take care to clean out the hollow legs. Use dry nitrogen to dry off the weldments.	BRIVERA	G-Q4-98
2	Request Waver	8-28-98		A waiver from the full cleaning procedure of E960022 has been requested from the Vacuum Board. Waiver has been approved. See LIGO-E980250-00-D	J. Romie/ JHR	4-16-99

N.B.: A copy of this traveler must be submitted to the DCC each time the original is shipped with the associated part(s) and when the traveler has been completed.

LIGO PROCESS TRAVELER

DCC Number: E990357-00-X

5 701	職業所 11 日日日日日日城場はからまる	Para de la compania	Barrier I Herrica Rei	上种 / 是 经净的产品根据影响 经发现的股份的联络的 (1986-1986) (1986-1986) (1986-1986) (1986-1986) (1986-1986) (1986-1986) (1986-1986)		
#	Operation	Start Date	Work Area	Instructions Bake per F960022 for stainless parts	Name/ Initials	Date Comp
3		9.2499	LLO	Bake per E960022 for stainless parts. Bake in vacuum at 200 deg C for 48 hours.	BRNER	9.2089
4	Control Point			Review/approve RGA scan #OS 2269 C. ROP	D. Coyne/S. Whiteomb	9/28/99
5	Wrap & Tag vacuum clean parts per E960022-A	9.9899	LLO	Wrap parts as appropriate to prevent contamination. Double wrap with clean foil and wrap in CP Stat bag. Tag the outside CPStat bag with the part number.	BRIVERA	9.29.99
6	Store		LLO	Store at LH0 for suspensions. Note: Copy this traveler and give to the DCC Keep original traveler with these parts.		
E	D: Go to Traveler associated	with next high	er assembly p		1	1

Special Instructions (Handling/Packaging Constraints, Remarks, etc.) or Notes:

Date	Name	Instructions/Comments
 		
	<u> </u>	

LIGO	PROCESS	TRAVELER
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DCC	Number:	
	I TILLIDOR O	1

LIGO PROCESS TRAVELER

DCC Number:

E990335-00-X

Date Prepared:

8/31/99

Originator.		Cos	gnizant Engineer	Ext./Phone#	Project's:	Number
L. Jones	L. Joi	nes		2970	LIGO	5F611
Dwg/Part Number	Rev		Part Description	Se	rial Number	Qly 1
(MDC) KAP-R25-300SC	2 Kap	ton Ribbon	Cable (with PEEK connectors)	N/A	(2015年1月1日 日本) - 1月1日日本日本日本日本日本日本日本日本日本日本日本日本日本日本日本日本日本日本	7
Used In (next higher ass	angklati = × Cuman	_;				
	enuny): Suspen	sion control	system	•		
	Vendor N	ame		PO/O	ontract Number	
MDC Vacuum Products C	F.U. (\$250)			PP297789-75LJ		1990年
Pata Package, Receiving/	Inspection Remarks			1 201 100-13133		
Inspection Vis	ual				Name/	Date ***
Required Y/N Damag	<u> Palandes destruiteristes di Masile d</u>		Comments		Initials	Comp.
Y	Rework req	uired to pro	ovide adequate clearance at conn o corrrect mirrored pin condition	ector corners	LARRY JONES	9/1/99
Process Flow:	Reassemon	- required to	o correct mirrored pin condition		JOSH WELSC	7/1/99
		Work			Name/	Date
# Operation	Start Date	Area	instruc	tions	Initials	Compre
1 Control Point	NA	NA	Hold for completion of the i required	nspection (above) if	NA	NA
2 Clean	S.H99	LHO	per LIGO-E960022-		3.1C,UEICA	
			(also see special instructions	s below)	1	9.20.99%
3 Vacuum Bake	9-2459	LHO	per LIGO-E960022-		B. RNELA	9.2859
			(also see special instructions	s below)	12:15:10	7.42.77
4 6 . 18					2/	
4 Control Point		NA	Review/approve RGA:scan		D. Coyne	9/28/90
			scan		_ or S. Whitcon	mo j
			Note: attach RGA scan(s) to		 -	1

N.B.: A copy of this traveler must be submitted to the DCC each time the original is shipped with the associated part(s) and when the traveler has been completed.

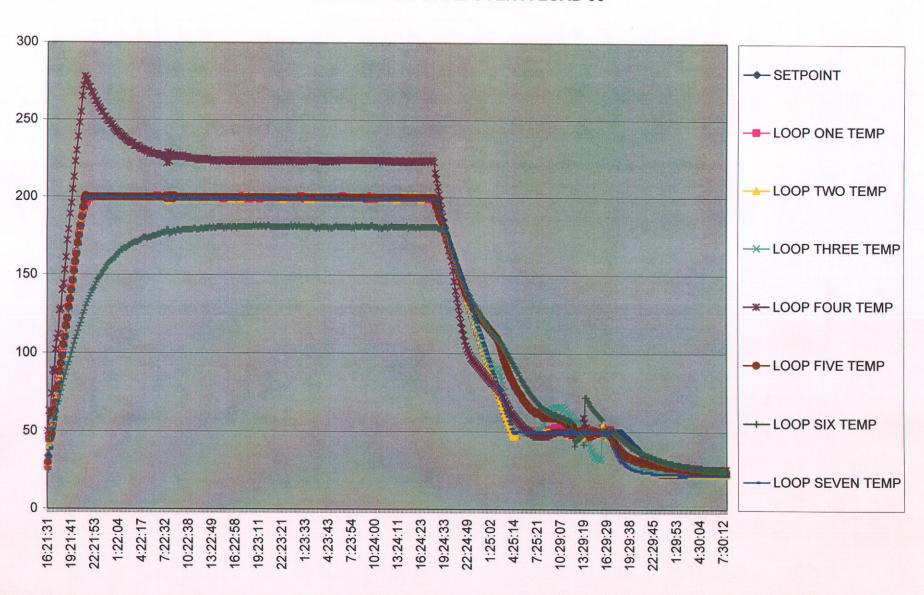
DCC Number: | E990335-00-X

#	Operation	Start Date	Work Area	AT PER LET SE		Instructions T	Name/ Initials	Date Comp.
5	Check continuity	Assembly Children (Children and Children and	LHO	Confi	rmation of e	continuity after bake	The state of the s	
6	Wrap & Tag parts		LHO	per Ll warni	GO-E9600 ng" and "U	22- ; Use LIGO "UHV cle HV parts label" stickers	ean	
				No.	Qty per package	Part		
			·	(1)	1	Kapton ribbon cable		
	·							
7	Store			(see al	lso qty. for	each shipping destination be	elow)	
	Store		LHO	place Note:	parts in LH Copy this	O Vacuum Prep Lab cabinet traveler and give to the DO	CC	
E	ND: Go to Traveler associated	with next highe	er assamble -	rogge				
L	- I a sociated	Heat inglie	r assembly L	nocessii	ıg			

Special Instructions (Handling/Packaging Constraints, Remarks, etc.) or Notes:

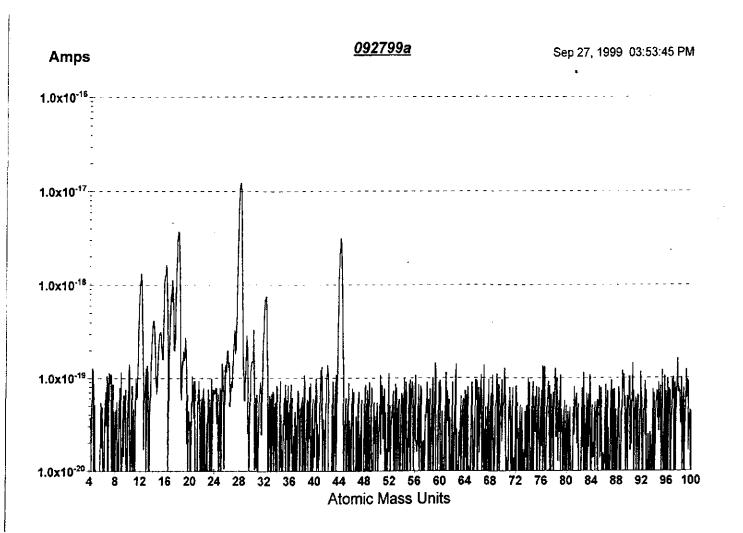
SOLIE FLAKING FROM PEEK CONNECTIONS NOTED BRIVERA 9.14.99, 9.20.99 RECLEANED INSTRUCTED STAN WHITCHAS, SOLVENT SOLUTION CLEAR LITRASOUR PROTA BRIVERA

LHO VACUUM BAKE OVEN A LOAD 58



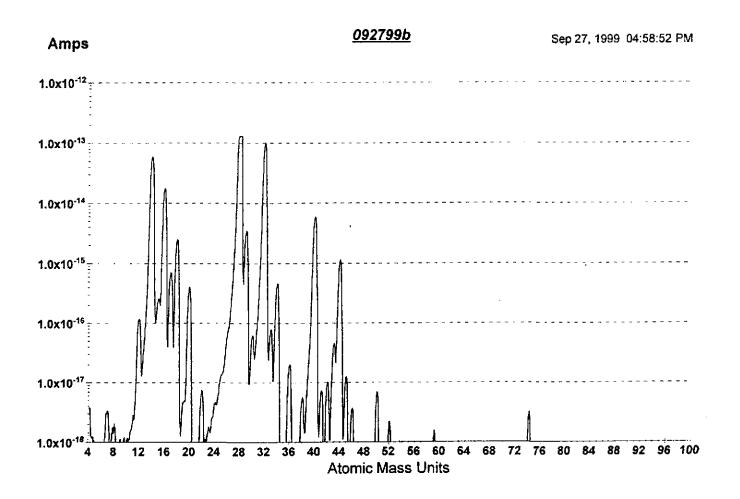
LHO VACUUM BAKE OVEN A LOAD #58 ELEVATED TEMPERATURE BACKGROUND SCAN

V-1 Closed



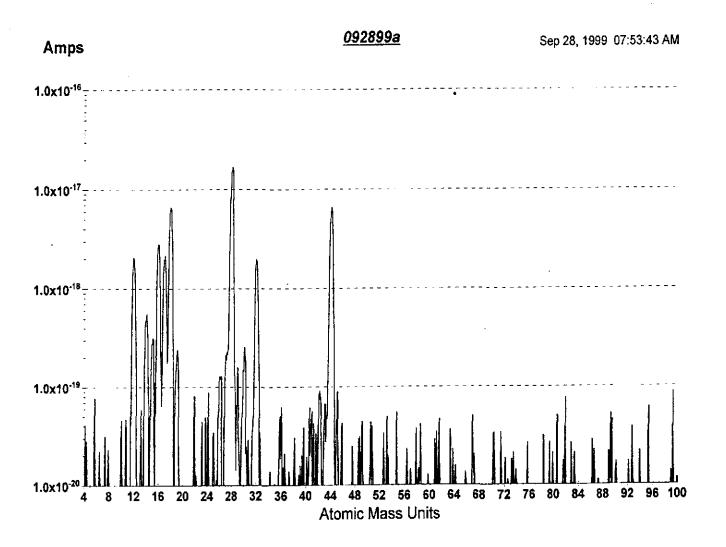
LHO VACUUM BAKE OVEN A LOAD #58 ELEVATED TEMPERATURE SCAN

V-1 Open, Cal-Gas and V-2 Closed, 50°C



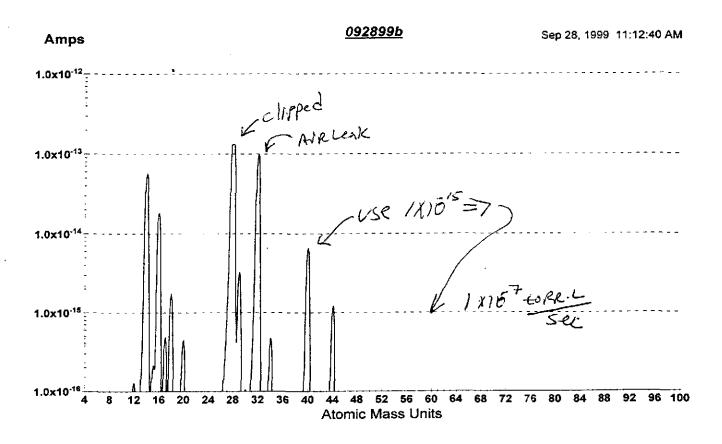
LHO Vacuum Bake Oven A Load #58 RGA Background

V-1 closed, room temperature



LHO Vacuum Bake Oven A Load #58 Calibration

V-1 and cal-gas open V-2 closed in pressure equilibrium at room temperature



CF defined as $P_{calc(40)}/I_{meas(40)}$

 $P_{\text{calc}(40)} = (\text{leak rate}) / (\text{pump speed}) = (1.1\text{E}-7 \text{ torr} \bullet \text{L/sec})(0.86) / (5 \text{ L/sec}) = 1.8\text{E}-8 \text{ torr}$

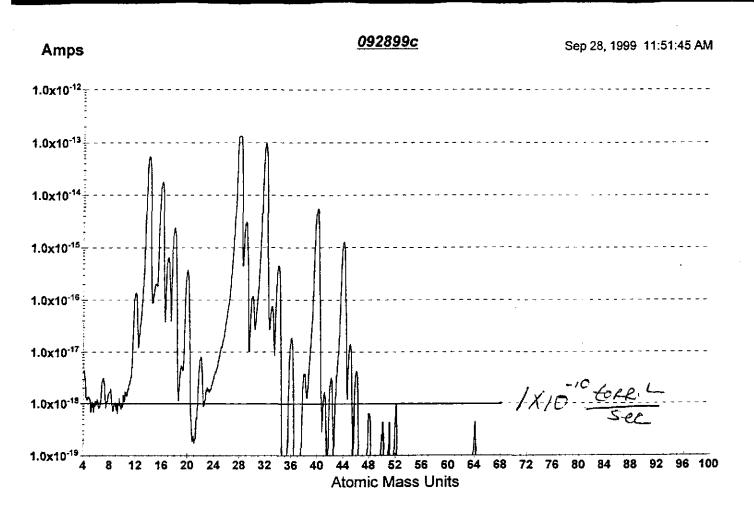
 $I_{meas(40)} \sim 1E-15$ amps *

CF = (1.8E-8 torr) / (1E-15 amps) = 2E7 torr/amps

^{*} A portion of the AMU40 signal (~4.0% of the AMU32 signal i.e. 0.04 x 1E-13 amps = 4E-15 amps) is due to the obvious air leak. Since this configuration has a long history of measured current being 1E-15 amps this value will be used.

LHO Vacuum Bake Oven A Load #58 Post-Bake Scan Room Temp.

V-1 open, Cal-Gas and V-2 Closed



LHO Bake Oven A Load # 58

1st Order Desorption Outgassing Rate Estimates using $Q_{low} = SP_{low} = SP_{high}[e^{(E_s/kT_{high})}]/[e^{(E_s/kT_{low})}]$

Number of units in bake load	Pump Speed (L/sec)	AMU	RGA background current (amps)	RGA current (amps) @ High Temp	Calibration Factor CF (torr/amps)	High Temp (K)	Low Temp (K)	Es/k	Extrapolated outgassing rate (torr*L/sec) @ T _{low}
1	5	41	5.60E-20	1.70E-18	2.00E+07	3.23E+02	2.97E+02	13000	4.85E-12
1	5	43	6.60E-20	9.30E-18	2.00E+07	3.23E+02	2.97E+02	8000	1.06E-10
1	5	53	0.00E+00	below noise	2.00E+07	3.23E+02	2.97E+02	13000	below noise
1	5	55	0.00E+00	below noise	2.00E+07	3.23E+02	2.97E+02	15000	below noise
1	5	57	0.00E+00	below noise	2.00E+07	3.23E+02	2.97E+02	15000	below noise